

BARREL IMAGING CALORIMETER: MEETINGS



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SUMMARY OF WEEKLY MEETINGS

Summary of new BIC meeting times:

- Mondays 5 pm CT: Topical meetings
- •Tuesdays 8 am CT: Weekly simulation meeting and ad-hoc topical meetings
- Tuesdays 2 pm CT: Weekly simulation meeting
- •Wednesday 8 am CT: Weekly AstroPix meeting [non-BIC]
- •Fridays 8 am CT: General meeting or topical meetings
- •Fridays 4 pm CT: Weekly Argonne mechanical engineering meeting
- •You can add all current and future BIC meetings to your calendar through the top level indico by clicking on the calendar icon in the top right: https://indico.bnl.gov/category/485/
- You can also sign up for any EIC email list at <u>lists.bnl.gov</u>
 - •BIC: Epic-bemcal-l
- •If you would like to join the AstroPix meetings, please send a request to Regina

Caputo: regina.caputo@nasa.gov



LAST MONTH'S MEETINGS

Meeting schedule:

1.ESB (End-of-Sector Box): Monday 2/19@4:30pm - Box Interfaces

- Objective: Freeze interfaces at this meeting (or define path to freeze interfaces by 3/15)
- https://indico.bnl.gov/event/22370/

2.Modules: Monday 2/26@5:00pm - Module Design

- Objective: determine the general geometry & path to finalize the mechanical design by 3/11
- https://indico.bnl.gov/event/22371/

3.General Meeting: Friday 3/1@8:00am

https://indico.bnl.gov/event/22372/



NEXT MONTH'S MEETINGS

4.Chips & Wafers: Friday 3/8@8:00am Wafer Testing

- Objective: Preliminary production QC wafer testing plan
- https://indico.bnl.gov/event/22373/

5.Modules/Mechanical: Monday 3/11@5:00pm Tray Mechanical Design

- Objective: Finalize module mechanical specifications
- https://indico.bnl.gov/event/22376/

6.ESB: Friday 3/15@8:00am SiPM Topical Meeting

- Objective: Review design concepts and freeze interface specifications
- https://indico.bnl.gov/event/22377/

7.Mechanical: Friday 3/22@8:00am Global Design

- Objective: Discuss strategies for rigidity and deformation.
 Decide on needed test articles and plan priorities
- https://indico.bnl.gov/event/22378/



UPCOMING WORKSHOPS

8.Mini-Workshop @Virtual Friday 3/29@8am-12pm Central

- General meeting
- Review all interface specifications
- Review CAD interface drawings and specification documents
 - Global BIC mechanics
 - EOSB (end of sector box)
 - Module
 - Wafer QC
- Updates
 - AstroPix
 - Coverage physics simulation
 - SiPM selection
- Discuss near-term PED phase plans
- Objective: Freeze specifications for Revision 1
 - Review designs at the May workshop
- https://indico.bnl.gov/event/22516/



UPCOMING WORKSHOPS

In-person Workshop @ANL → **May 14-17 (Tu-Fr (noon))**

- https://indico.bnl.gov/event/22517/
- Objective: preliminary designs of all major components for review
 - Discuss any needed changes in specification (Rev2)
- Please start your travel plans! We hope to see everyone there.

BACKUP

Argonne National Laboratory



NASA Goddard Space Flight Center



Oklahome State University



University of Connecticut



University of California Santa Cruz



University of Manitoba University of Regina





Mount Allison University



Canada Fund for Innovation



nank

Kyungpook National University



Yonsei

University of Seoul



Pusan National University





Korea

University



Sungkyunkwan

University



Hanyang

University

Gangneung-Wonju National University



Karlsruhe Institute of Technology



University of Giessen



ePIC BIC
Detector
Subsystem
Collaboration

AstroPix Collaboration:



Nagoya University